

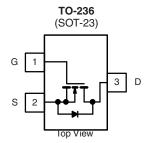
# ME2326B-VB Datasheet N-Channel 200 V (D-S) MOSFET

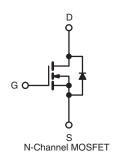
PRODUC	T SUMMARY	
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)
200	1.4 at V <sub>GS</sub> = 10 V	0.6

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- 100 %  $\rm R_{\rm g}$  and UIS Tested
- Trench Power MOSFET
- Compliant to RoHS Directive 2002/95/EC







Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	20	00	
Gate-Source Voltage		V <sub>GS</sub>	GS ± 20		V
Continuous Dunin Comment /T 150 °C\0	T <sub>A</sub> = 25 °C		0.6	0.45	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 70 °C	I <sub>D</sub>	0.5	0.35	^
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	2.	5	Α
Avalanche Current <sup>b</sup>	L = 0.1 mH	I <sub>AS</sub>	2.	.5	
Single Avalanche Energy	L = 0.1 min	E <sub>AS</sub>	5	0	mJ
Continuous Source Current (Diode Conduction) <sup>6</sup>	a .	I <sub>S</sub>	0	.6	Α
Dawar Dissination®	T <sub>A</sub> = 25 °C	D	1.55	1.03	W
Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C	$P_{D}$	1.20	0.87	VV
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stq</sub>	- 55 t	o 150	°C

THERMAL RESISTANCE RAT	INGS				
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a</sup>	t ≤ 5 s	R <sub>thJA</sub>	80	100	
Maximum Junction-to-Ambient	Steady State		130	170	°C/W
Maximum Junction-to-Foot	Steady State		45	55	

## Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. Pulse width limited by maximum junction temperature.

服务热线:400-655-8788

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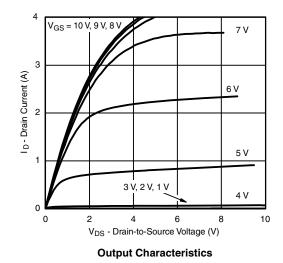
				Limits		
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				•		
Drain-Source Breakdown Voltage	$V_{DS}$	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	200			V
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.5		4.5	V
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zoro Cata Valtaga Drain Current		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$			1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = 100 V, $V_{GS}$ = 0 V, $T_J$ = 70 °C			75	μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 15 \text{ V}, V_{GS} = 10 \text{ V}$	2.5			Α
Drain-Source On-Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 0.5 A		1.4		Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 0.5 A		4		S
Diode Forward Voltage	$V_{SD}$	I <sub>S</sub> = 1 A, V <sub>GS</sub> = 0 V		0.8	1.2	V
Dynamic <sup>b</sup>						
Total Gate Charge	Qg			3	5	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 0.5 \text{ A}$		0.37		nC
Gate-Drain Charge	Q <sub>gd</sub>			1.45		
Gate Resistance	$R_{g}$		0.5	1.3	2.4	Ω
Switching	-					
Turn-On Delay Time	t <sub>d(on)</sub>			7	11	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 100 V, $R_L$ = 33 $\Omega$		10	15	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 0.2 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		9	15	ns
Fall Time	t <sub>f</sub>			11	15	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	$I_F = 0.5 \text{ A}, dI/dt = 100 \text{ A}/\mu \text{s} 50100$				

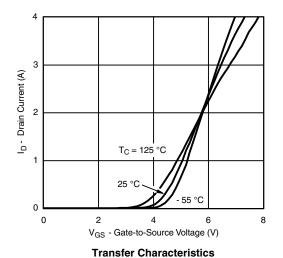
#### Notes:

- a. Pulse test: PW  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

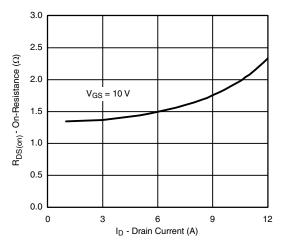
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



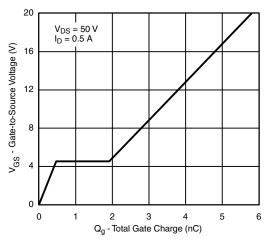




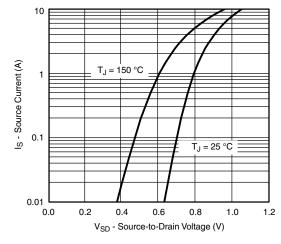
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



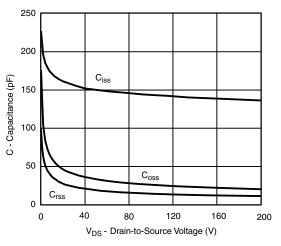
#### On-Resistance vs. Drain Current



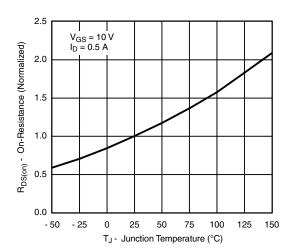
**Gate Charge** 



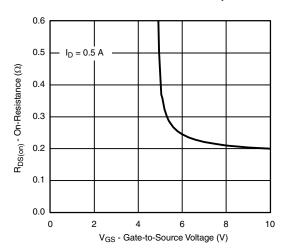
Source-Drain Diode Forward Voltage



Capacitance



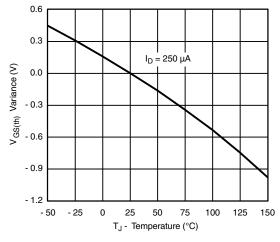
On-Resistance vs. Junction Temperature

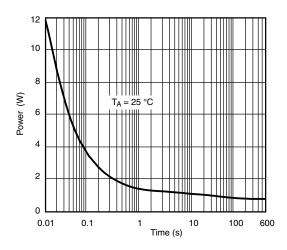


On-Resistance vs. Gate-to-Source Voltage



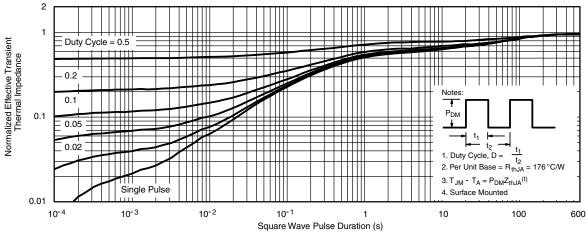
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





#### **Threshold Voltage**

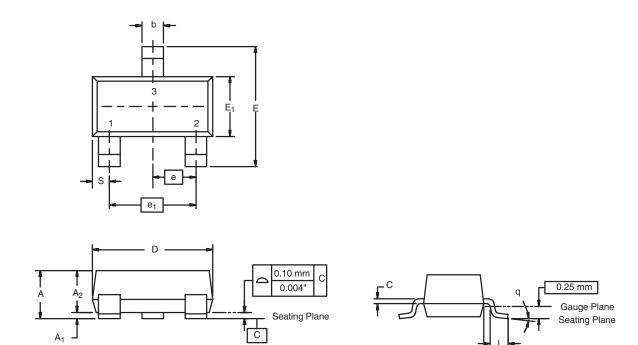
Single Pulse Power



Normalized Thermal Transient Impedance, Junction-to-Ambient



## SOT-23 (TO-236): 3-LEAD



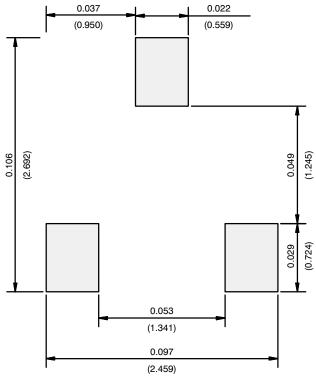
Dim	MILLIMETERS		INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	

DWG: 5479



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## **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)



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